Analog Multiplexers/ Demultiplexers with Injection Current Effect Control with LSTTL Compatible Inputs

Automotive Customized

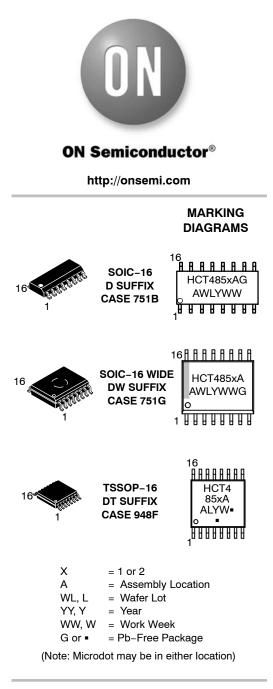
This device is pin compatible to standard HC405x and MC1405xB analog mux/demux devices, but feature injection current effect control. This makes them especially suited for usage in automotive applications where voltages in excess of normal logic voltage are common.

The injection current effect control allows signals at disabled analog input channels to exceed the supply voltage range without affecting the signal of the enabled analog channel. This eliminates the need for external diode/ resistor networks typically used to keep the analog channel signals within the supply voltage range.

The devices utilize low power silicon gate CMOS technology. The Channel Select and Enable inputs are compatible with standard CMOS or LSTTL outputs.

Features

- Injection Current Cross-Coupling Less than 1mV/mA (See Figure 6)
- Pin Compatible to HC405x and MC1405xB Devices
- Power Supply Range (V_{CC} GND) = 4.5 to 5.5 V
- In Compliance With the Requirements of JEDEC Standard No. 7 A
- Chip Complexity: 154 FETs or 36 Equivalent Gates
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 11 of this data sheet.

1

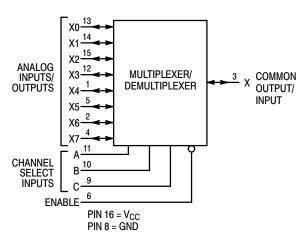


Figure 1. MC74HCT4851A Logic Diagram Single-Pole, 8-Position Plus Common Off

FUNCTION TABLE - MC74HCT4851A

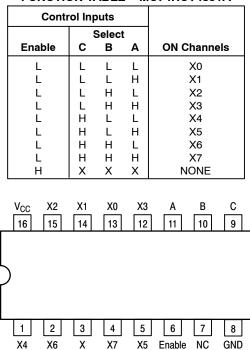


Figure 2. MC74HCT4851A 16-Lead Pinout (Top View)

FUNCTION TABLE - MC74HCT4852A

Control Inputs				
Enable	Se B	lect A	ON Ch	annels
L	L	L H	Y0 Y1	X0 X1
L L H	H H X	L H X	Y2 Y3 NO	X2 X3 NE

X = Don't Care

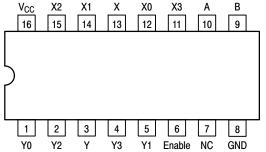
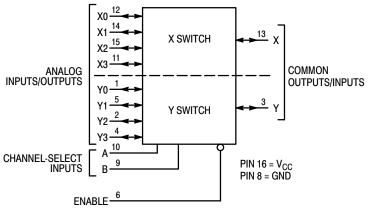
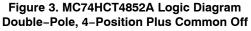


Figure 4. MC74HCT4852A 16-Lead Pinout (Top View)





MAXIMUM RATINGS

Symbol	Paramete	Value	Unit	
V _{CC}	Positive DC Supply Voltage	(Referenced to GND)	-0.5 to + 7.0	V
V _{in}	DC Input Voltage (Any Pin)	(Referenced to GND)	-0.5 to V _{CC} + 0.5	V
I	DC Current, Into or Out of Any	' Pin	±25	mA
PD	Power Dissipation in Still Air,	SOIC Package† TSSOP Package†	500 450	mW
T _{stg}	Storage Temperature Range		—65 to + 150	°C
ΤL	Lead Temperature, 1 mm from SO	Case for 10 Seconds IC or TSSOP Package	260	°C

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high–impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range GND $\leq (V_{in} \text{ or } V_{out}) \leq V_{CC}$.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit	
V _{CC}	Positive DC Supply Voltage (Referen	nced to GND)	4.5	5.5	V
V _{in}	DC Input Voltage (Any Pin) (Referen	nced to GND)	GND	V _{CC}	V
V _{IO} *	Static or Dynamic Voltage Across Swite	h	0.0	1.2	V
T _A	Operating Temperature Range, All Pacl	kage Types	- 55	+ 125	°C
t _r , t _f	Input Rise/Fall Time (Channel Select or Enable Inputs)	$V_{CC} = 2.0 V$ $V_{CC} = 4.5 V$ $V_{CC} = 6.0 V$	0 0 0	1000 500 400	ns

*For voltage drops across switch greater than 1.2 V (switch on), excessive V_{CC} current may be drawn; i.e., the current out of the switch may contain both V_{CC} and switch input components. The reliability of the device will be unaffected unless the Maximum Ratings are exceeded.

DC CHARACTERISTICS — Digital Section (Voltages Referenced to GND) VEE = GND, Except Where Noted

			v _{cc}	Guaranteed Limit			
Symbol	Parameter	Condition	v	–55 to 25°C	≤ 85°C	≤125°C	Unit
V _{IH}	Minimum High-Level Input Voltage, Channel-Select or Enable Inputs	R _{on} = Per Spec	4.5 to 5.5	2.0	2.0	2.0	V
VIL	Maximum Low-Level Input Voltage, Channel-Select or Enable Inputs	R _{on} = Per Spec	4.5 to 5.5	0.8	0.8	0.8	V
l _{in}	Maximum Input Leakage Current on Digital Pins (Enable/A/B/C)	V _{in} = V _{CC} or GND	5.5	± 0.1	±1.0	± 1.0	μΑ
I _{CC}	Maximum Quiescent Supply Current (per Package)	V _{in(digital)} = V _{CC} or GND V _{in(analog)} = GND	5.5	2.0	20	40	μΑ

DC CHARACTERISTICS — Analog Section

				Guara	nteed Lin	nit	
Symbol	Parameter	Condition	v_{cc}	–55 to 25°C	≤ 85°C	≤125°C	Unit
R _{on}	Maximum "ON" Resistance	$V_{in} = V_{IL} \text{ or } V_{IH}; V_{IS} = V_{CC} \text{ to}$ GND; $I_S \le 2.0 \text{ mA}$	4.5 5.5	550 400	650 500	750 600	Ω
ΔR_{on}	Delta "ON" Resistance		4.5 5.5	80 60	100 80	120 100	Ω
l _{off}	Maximum Off-Channel Leakage Current, Any One Channel Common Channel	V _{in} = V _{CC} or GND	5.5	±0.1 ±0.1	±0.1 ±0.1	±0.1 ±0.1	μΑ
I _{on}	Maximum On-Channel Leakage Channel-to-Channel	$V_{in} = V_{CC} \text{ or } GND$	5.5	±0.1	±0.1	±0.1	μA

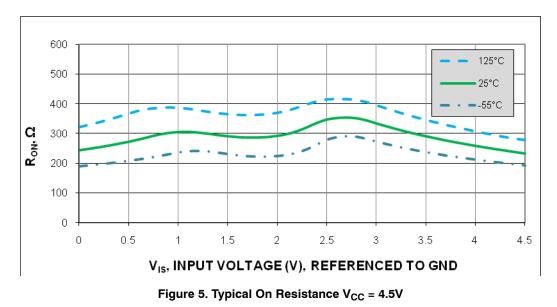
AC CHARACTERISTICS (CL = 50 pF, Input t_r = t_f = 6 ns, V_{CC} = 5.0 V \pm 10%)

Symbol	Parame	Parameter		–55 to 25°C	≤ 85°C	≤125°C	Unit
t _{PHL} , t _{PLH}	Maximum Propagation Delay, Analog Input to Analog Output		5.0	40	45	50	ns
t _{PHL} , t _{PHZ,PZH} t _{PLH} , t _{PLZ,PZL}	Maximum Propagation Delay, Enable or Channel-Select to Analog Output		5.0	80	90	100	ns
C _{in}	Maximum Input CapacitanceDigital Pins(All Switches Off)Any Single Analog Pin(All Switches Off)Common Analog Pin			10 35 40	10 35 40	10 35 40	pF
C _{PD}	Power Dissipation Capacitance	Typical	5.0	20			pF

INJECTION CURRENT COUPLING SPECIFICATIONS ($V_{CC} = 5V$, $T_A = -55^{\circ}C$ to $+125^{\circ}C$)

Symbol	Parameter	Condition	Тур	Max	Unit
$V\Delta_{out}$	Maximum Shift of Output Voltage of Enabled Analog Channel	$I_{in}^* \le 1$ mA, $R_S \le 3.9$ k Ω	0.1	1.0	mV
		$I_{in}^* \le 10 \text{ mA}, R_S \le 3.9 \text{ k}\Omega$	1.0	5.0	
		l _{in} * ≤ 1 mA, R _S ≤ 20 kΩ	0.5	2.0	
		$I_{in}^{*} \le 10 \text{ mA}, R_{S} \le 20 \text{ k}\Omega$	5.0	20	

* I_{in} = Total current injected into all disabled channels.



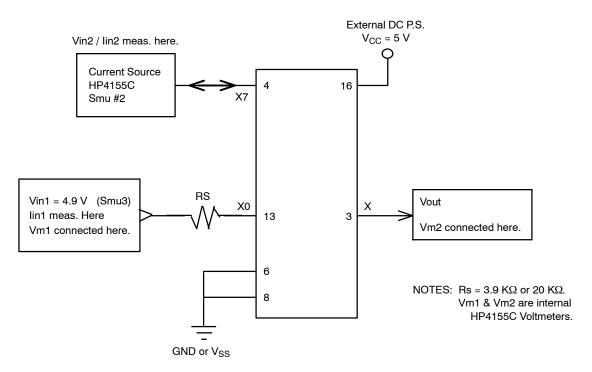


Figure 6. Injection Current Coupling Specification

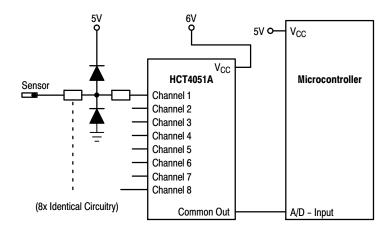


Figure 7. Actual Technology Requires 32 passive components and one extra 6V regulator to suppress injection current into a standard HCT4051 multiplexer

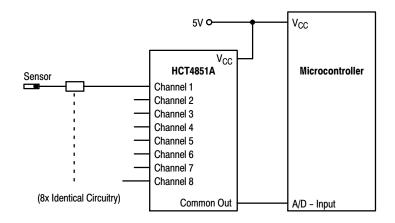


Figure 8. MC74HCT4851A Solution Solution by applying the HCT4851A multiplexer

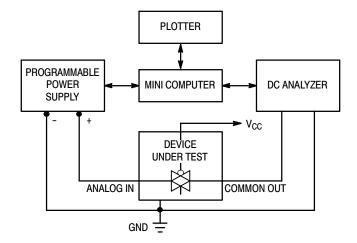


Figure 9. On Resistance Test Set-Up

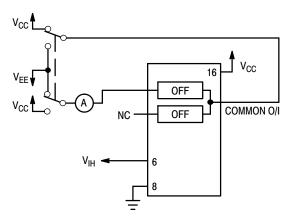


Figure 10. Maximum Off Channel Leakage Current, Any One Channel, Test Set-Up

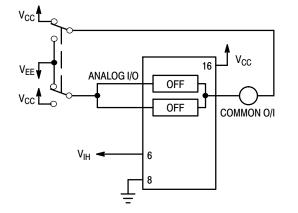


Figure 11. Maximum Off Channel Leakage Current, Common Channel, Test Set–Up

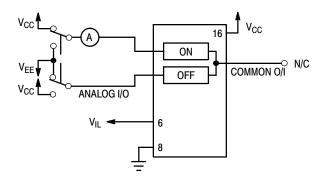
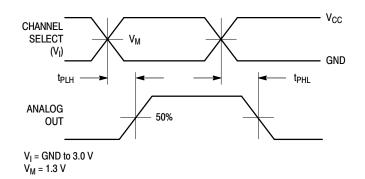
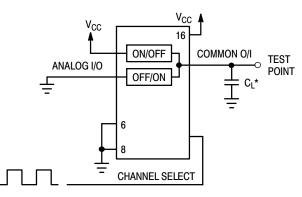


Figure 12. Maximum On Channel Leakage Current, Channel to Channel, Test Set–Up

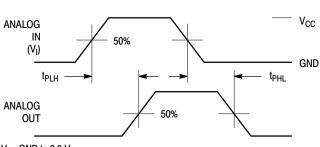






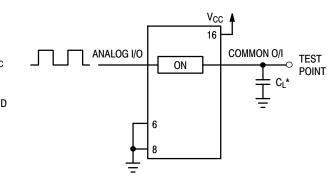
*Includes all probe and jig capacitance





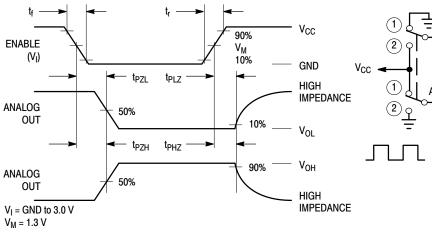
 $V_I = GND \text{ to } 3.0 \text{ V}$ $V_M = 1.3 \text{ V}$

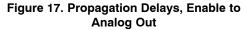


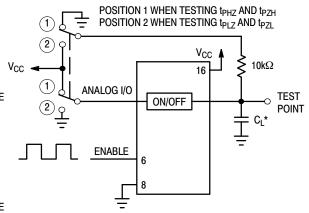


*Includes all probe and jig capacitance

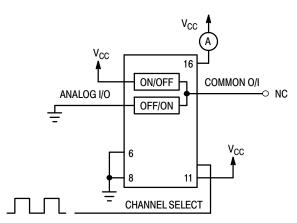
Figure 16. Propagation Delay, Test Set–Up Analog In to Analog Out













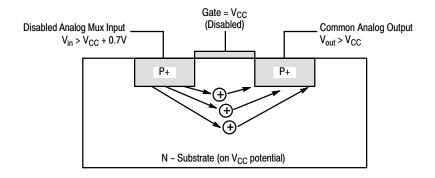


Figure 20. Diagram of Bipolar Coupling Mechanism

Appears if V_{in} exceeds V_{CC} , driving injection current into the substrate

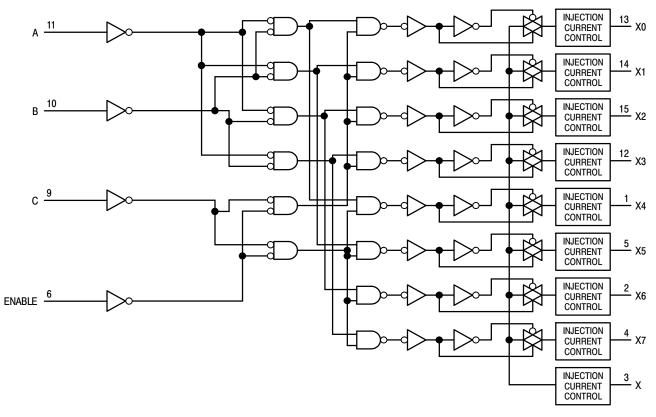
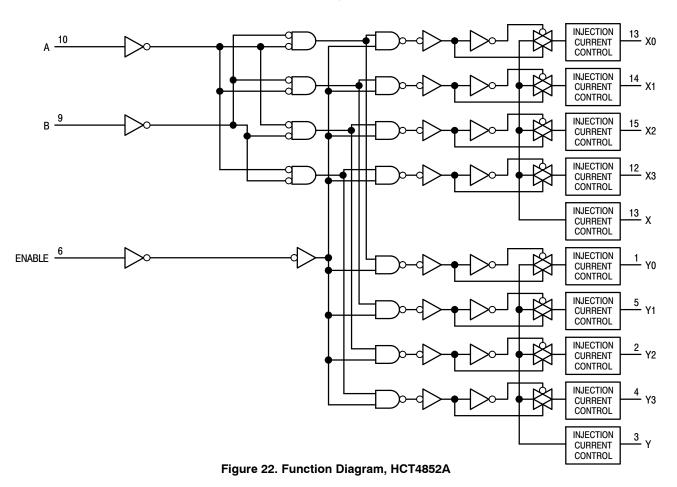


Figure 21. Function Diagram, HCT4851A



ORDERING INFORMATION

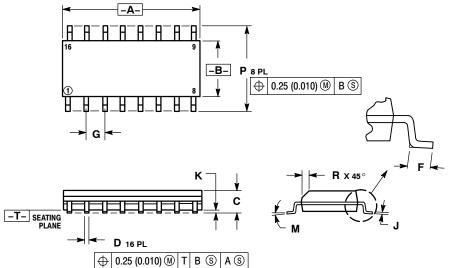
Device	Package	Shipping [†]
MC74HCT4851ADG	SOIC-16 (Pb-Free)	48 Units / Rail
MC74HCT4851ADR2G	SOIC-16 (Pb-Free)	2500 Units / Tape & Reel
NLV74HCT4851ADR2G*	SOIC-16 (Pb-Free)	2500 Units / Tape & Reel
MC74HCT4851ADTG	TSSOP-16 (Pb-Free)	48 Units / Rail
M74HCT4851ADTR2G	TSSOP-16 (Pb-Free)	2500 Units / Tape & Reel
NLVHCT4851ADTR2G*	TSSOP-16 (Pb-Free)	2500 Units / Tape & Reel
M74HCT4851ADWR2G	SOIC-16 WIDE (Pb-Free)	1000 Units / Tape & Reel
MC74HCT4852ADG	SOIC-16 (Pb-Free)	48 Units / Rail
MC74HCT4852ADR2G	SOIC-16 (Pb-Free)	2500 Units / Tape & Reel
MC74HCT4852ADTG	TSSOP-16 (Pb-Free)	48 Units / Rail
M74HCT4852ADTR2G	TSSOP-16 (Pb-Free)	2500 Units / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D. *NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP

Capable.

PACKAGE DIMENSIONS

SOIC-16 **D SUFFIX** CASE 751B-05 **ISSUE K**

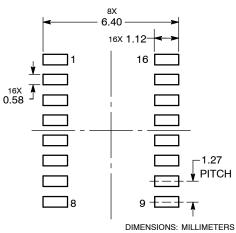


NOTES:

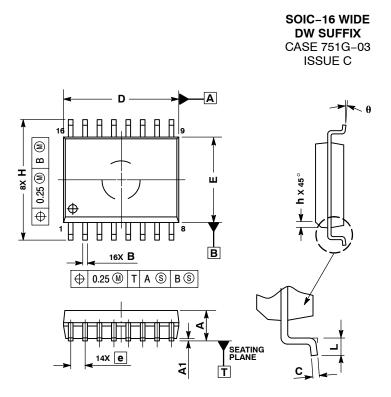
- NOTES:
 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETER.
 DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
 MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
 DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIN	IETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	9.80	10.00	0.386	0.393
В	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27	BSC	0.050	BSC
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
М	0 °	7°	0°	7°
Ρ	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

SOLDERING FOOTPRINT



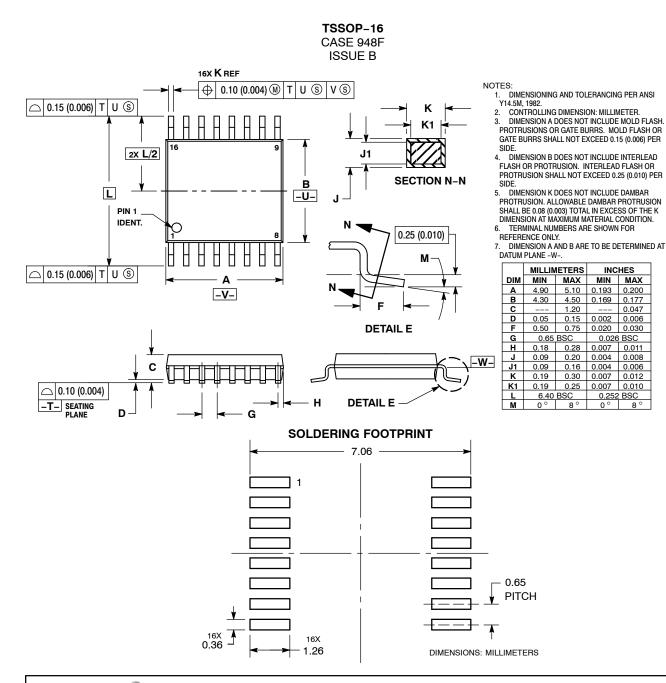
PACKAGE DIMENSIONS



- NOTES:
 DIMENSIONS ARE IN MILLIMETERS.
 INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
 DIMENSIONS D AND E DO NOT INLCUDE MOLD PROTRUSION.
 MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
 DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF THE B DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIMETERS				
DIM	MIN	MAX			
Α	2.35	2.65			
A1	0.10	0.25			
В	0.35	0.49			
С	0.23	0.32			
D	10.15	10.45			
Е	7.40	7.60			
е	1.27	BSC			
Н	10.05	10.55			
h	0.25	0.75			
L	0.50	0.90			
q	0 °	7 °			

PACKAGE DIMENSIONS



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0.252 BSC

0

0.200

0.047

0.006

0.011

0.012

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